











**TLV1117** 

# SLVS561L - DECEMBER 2004-REVISED OCTOBER 2014 **TLV1117 Adjustable and Fixed Low-Dropout Voltage Regulator**

# **Features**

- 1.5-V, 1.8-V, 2.5-V, 3.3-V, 5-V, and Adjustable-Output Voltage Options
- Output Current of 800 mA
- Specified Dropout Voltage at Multiple **Current Levels**
- 0.2% Line Regulation Maximum
- 0.4% Load Regulation Maximum

# **Applications**

- Electronic Points of Sale
- Medical, Health, and Fitness Applications
- **Printers**
- Appliances and White Goods
- TV Set-Top Boxes

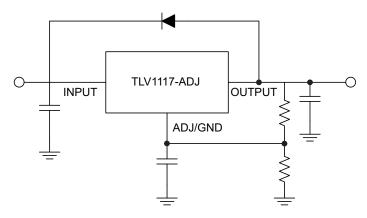
# 3 Description

The TLV1117 device is a positive low-dropout voltage regulator designed to provide up to 800 mA of output current. The device is available in 1.5-V, 1.8-V, 2.5-V, 3.3-V, 5-V, and adjustable-output voltage options. All internal circuitry is designed to operate down to 1-V input-to-output differential. Dropout voltage is specified at a maximum of 1.3 V at 800 mA, decreasing at lower load currents.

#### **Device Information**

| ORDER NUMBER | PACKAGE (PIN)        | BODY SIZE          |
|--------------|----------------------|--------------------|
| TLV1117DCY   | SOT-223 (4)          | 6.50 mm × 3.50 mm  |
| TLV1117DRJ   | SON (8)              | 4.00 mm × 4.00 mm  |
| TLV1117KVU   | TO-252 (3)           | 6.60 mm × 6.10 mm  |
| TLV1117KCS   | TO-220 (3)           | 10.16 mm × 8.70 mm |
| TLV1117KCT   | TO-220 (3)           | 10.16 mm × 8.59 mm |
| TLV1117KTT   | DDPAK,<br>TO-263 (3) | 10.18 mm × 8.41 mm |

# **Simplified Schematic**





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# Changes from Revision K (April 2013) to Revision L

| • | Updated data sheet to new TI standards – no specification changes. | 1   |
|---|--|-----|
| • | Deleted Ordering Information table.                                | . 1 |
| • | Added Applications   | . 1 |
| • | Added Device and Documentation Support section                     | 14  |
| • | Added Mechanical, Packaging, and Orderable Information section.    | 14  |

# **5** Revision History

## Changes from Revision J (April 2013) to Revision K

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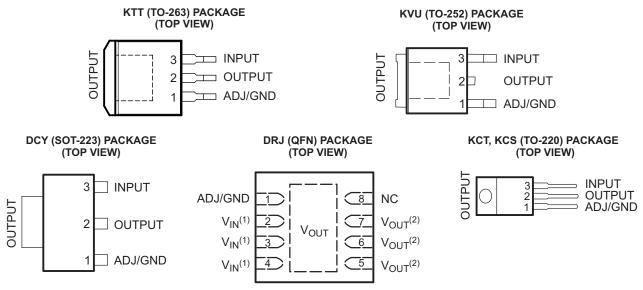
Added additional package options.
 Added ESD warning.

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# 6 Pin Configuration and Functions



(1)  $V_{\mbox{\scriptsize IN}}$  pins (2, 3, 4) must be connected together.

**Table 1. Pin Functions** 

| PIN     |     |     |     |         |     | TYPE | DESCRIPTION   |  |  |
|---------|-----|-----|-----|---------|-----|------|---|--|--|
| NAME    | KTT | KVU | DCY | DRJ     | КСТ | ITPE | DESCRIPTION   |  |  |
| ADJ/GND | 1   | 1   | 1   | 1       | 1   | I/O  | Output voltage adjustment pin. Connect to a resistor divider. |  |  |
| INPUT   | 3   | 3   | 3   | 2, 3, 4 | 3   | I    | Voltage input   |  |  |
| OUTPUT  | 2   | 2   | 2   | 5, 6, 7 | 2   | 0    | Voltage output  |  |  |
| NC      | -   | -   | -   | 8       | -   | -    | No connect  |  |  |

<sup>(2)</sup> V<sub>OUT</sub> pins (5, 6, 7) must be connected together.



# 7 Specifications

# 7.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|          |  | MIN | MAX | UNIT |
|----------|--|-----|-----|------|
| $V_{IN}$ | Continuous input voltage               |     | 16  | V    |
| $T_{J}$  | Operating virtual-junction temperature |     | 150 | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# 7.2 Handling Ratings

|                    |                          |   | MIN | MAX  | UNIT |  |  |
|--------------------|--------------------------|---|-----|------|------|--|--|
| T <sub>stg</sub>   | Storage temperature rang | orage temperature range   |     |      |      |  |  |
| V                  | Electrostatic discharge  | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>   | 0   | 2500 | \/   |  |  |
| V <sub>(ESD)</sub> | Electrostatic discharge  | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2) | 0   | 1500 | V    |  |  |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 7.3 Recommended Operating Conditions

|                 |   |            | MIN <sup>(1)</sup> | MAX | UNIT |
|-----------------|---|------------|--------------------|-----|------|
| V <sub>IN</sub> |   | TLV1117    | 2.7                | 15  |      |
|                 |   | TLV1117-15 | 2.9                | 15  |      |
|                 |   | TLV1117-18 | 3.2                | 15  | V    |
|                 | Input voltage                               | TLV1117-25 | 3.9                | 15  | V    |
|                 |   | TLV1117-33 | 4.7                | 15  |      |
|                 |   | TLV1117-50 |                    | 15  |      |
| lo              | Output current                              | •          |                    | 0.8 | Α    |
| <b>-</b>        | On a ratio a virtual impation to manaratura | TLV1117C   | 0                  | 125 | °C   |
| $T_J$           | Operating virtual-junction temperature      | TLV1117I   | -40                | 125 | , C  |

<sup>(1)</sup> The input-to-output differential across the regulator should provide for some margin against regulator operation at the maximum dropout (for a particular current value). This margin is needed to account for tolerances in both the input voltage (lower limit) and the output voltage (upper limit). The absolute minimum V<sub>IN</sub> for a desired maximum output current can be calculated by the following:

V<sub>IN(min)</sub> = V<sub>OUT(max)</sub> + V<sub>DO(max at rated current)</sub>



#### 7.4 Thermal Information

|                        |  |                  |        |                 | TLV111          | 7               |                      |                 |        |
|------------------------|--|------------------|--------|-----------------|-----------------|-----------------|----------------------|-----------------|--------|
|                        | THERMAL METRIC(1)(2)(3)  | Powe             | erFlex |                 |                 |                 |                      |                 | UNITS  |
|                        | THE NIME INC.  | KTE KTP (3 PINS) |        | DRJ<br>(8 PINS) | DCY<br>(4 PINS) | KVU<br>(3 PINS) | KCS, KCT<br>(3 PINS) | KTT<br>(3 PINS) | O.W.TO |
| $R_{\theta JA}$        | Junction-to-ambient thermal resistance   | 38.6             | 49.2   | 38.3            | 104.3           | 50.9            | 30.1                 | 27.5            |        |
| R <sub>θJC(top)</sub>  | Junction-to-case (top) thermal resistance                                      | 34.7             | 60.6   | 36.5            | 53.7            | 57.9            | 44.6                 | 43.2            |        |
| $R_{\theta JB}$        | Junction-to-board thermal resistance   | 3.2              | 3.1    | 60.5            | 5.7             | 34.8            | 1.2                  | 17.3            |        |
| Ψлт                    | Junction-to-top characterization parameter                                     | 5.9              | 8.7    | 0.2             | 3.1             | 6               | 5                    | 2.8             | °C/W   |
| ΨЈВ                    | Junction-to-board characterization parameter                                   | 3.1              | 3      | 12              | 5.5             | 23.7            | 1.2                  | 9.3             | 0,77   |
| R <sub>0</sub> JC(bot) | Junction-to-case (bottom) thermal resistance                                   | 3                | 3      | 4.7             | n/a             | 0.4             | 0.4                  | 0.3             |        |
| $R_{\theta JP}$        | Thermal resistance between the die junction and the bottom of the exposed pad. | 2.7              | 1.4    | 1.78            | n/a             | n/a             | 3                    | 1.94            |        |

For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953. For thermal estimates of this device based on PCB copper area, see the TI PCB Thermal Calculator. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A) / \theta J_A$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.



## 7.5 TLV1117C Electrical Characteristics

 $T_J = 0$ °C to 125°C, all typical values are at  $T_J = 25$ °C (unless otherwise noted)

| PARAMETER  | TEST CONDITIONS <sup>(1)</sup>  | •  | MIN   | TYP    | MAX   | UNIT |  |  |
|--|---|--|-------|--------|---|------|--|--|
| Defended and M   | V <sub>IN</sub> – V <sub>OUT</sub> = 2 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C       | T11/4447   | 1.238 | 1.25   | 1.262   |      |  |  |
| Reference voltage, V <sub>REF</sub>  | $V_{IN} - V_{OUT} = 1.4 \text{ V to } 10 \text{ V}, I_{OUT} = 10 \text{ mA to } 800 \text{ mA}$ | ILV1117  | 1.225 | 1.25   | 1.27  |      |  |  |
|  | V <sub>IN</sub> = 3.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                        | 1.485  | 1.5   | 1.515  |   |      |  |  |
|  | V <sub>IN</sub> = 2.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                 | II V1117-15  |       |        |   |      |  |  |
| Reference voltage, V <sub>REF</sub> Output voltage, V <sub>OUT</sub> Line regulation  Load regulation  Dropout voltage, V <sub>DO</sub> (2)  Current limit  Minimum load current  Quiescent current  Thermal regulation  Ripple rejection  ADJ pin current  Change in ADJ pin current  | V <sub>IN</sub> = 3.8 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                        | TI \ /4.447.40   | 1.782 | 1.8    | 1.818   |      |  |  |
|  | V <sub>IN</sub> = 3.2 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                 | TLV1117-18   | 1.746 | 1.8    | 1.854   |      |  |  |
|  | V <sub>IN</sub> = 4.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                        | TI \ /4.447.05   | 2.475 | 2.5    | 2.525   | V    |  |  |
| Output voltage, v <sub>OUT</sub>   | V <sub>IN</sub> = 3.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                 | TLV1117-25   | 2.450 | 2.5    | 2.550   |      |  |  |
| Reference voltage, V <sub>REF</sub> Output voltage, V <sub>OUT</sub> Line regulation  Load regulation  Dropout voltage, V <sub>DO</sub> (2)  Current limit  Minimum load current  Quiescent current  Thermal regulation  Ripple rejection  ADJ pin current  Change in ADJ pin current  | V <sub>IN</sub> = 5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                          | 3.267  | 3.3   | 3.333  |   |      |  |  |
|  | V <sub>IN</sub> = 4.75 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                | TLV1117-33   | 3.235 | 3.3    | 3.365   |      |  |  |
|  | V <sub>IN</sub> = 7 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                          | TI ) /4.447 FO   | 4.950 | 5.0    | 5.050   |      |  |  |
|  | V <sub>IN</sub> = 6.5 V to 12 V, I <sub>OUT</sub> = 0 to 800 mA                                 | TLV1117-50   | 4.900 | 5.0    | 5.100   |      |  |  |
|  | $I_{OUT} = 10 \text{ mA}, V_{IN} - V_{OUT} = 1.5 \text{ V to } 13.75 \text{ V}$                 | TLV1117  |       | 0.035% | 0.2%  | _    |  |  |
|  | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 2.9 V to 10 V  | TLV1117-15   |       | 1      | 6   |      |  |  |
| Reference voltage, $V_{REF}$ $V_{IN} - V_{IN} - V_{IN} - V_{IN} = V_{IN} =$ | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 3.2 V to 10 V  | TLV1117-18   |       | 1      | 6   |      |  |  |
|  | $I_{OUT} = 0$ mA, $V_{IN} = 3.9$ V to 10 V  | TLV1117-25   |       | 1      | 6   | mV   |  |  |
|  | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 4.75 V to 15 V                                       |  | 1     | 6      |   |      |  |  |
|  | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 6.5 V to 15 V  | TLV1117-50   |       | 1      | 10  |      |  |  |
|  | $I_{OUT} = 10 \text{ mA to } 800 \text{ mA}, V_{IN} - V_{OUT} = 3 \text{ V}$                    | TLV1117  |       | 0.2%   | 2.550 3.333 3.365 5.050 5.100 0.2% 6 6 6 6  | _    |  |  |
| Line regulation  Load regulation  Dropout voltage, V <sub>DO</sub> (2)  Current limit  Minimum load current  Quiescent current  Thermal regulation  Ripple rejection  ADJ pin current  Change in ADJ pin current  Temperature stability  | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 2.9 V   | TLV1117-15   |       | 1      | 10  |      |  |  |
|  | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 3.2 V   | TLV1117-18   |       | 1      | 10  |      |  |  |
|  | $I_{OUT} = 0$ to 800 mA, $V_{IN} = 3.9 \text{ V}$   | TLV1117-25   |       | 1      | 10  | mV   |  |  |
|  | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 4.75 V  |  | 1     | 10     |   |      |  |  |
|  | $I_{OUT} = 0$ to 800 mA, $V_{IN} = 6.5 \text{ V}$   | $\begin{array}{c} V_{OUT} = 1.4 \ V \ to 10 \ V, \ l_{OUT} = 10 \ mA \ to 800 \ mA \\ 3.5 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 2.9 \ V to 10 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 3.8 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 3.8 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 3.8 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 3.9 \ V to 10 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 4.5 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 3.9 \ V to 10 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 4.5 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 3.9 \ V to 10 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 5 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 3.9 \ V to 10 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 7 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 4.75 \ V to 10 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 7 \ V, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 6.5 \ V to 12 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 7 \ U, \ l_{OUT} = 10 \ mA, \ T_J = 25^{\circ}C \\ 6.5 \ V to 12 \ V, \ l_{OUT} = 0 \ to 800 \ mA \\ 7 \ U, \ m_{OUT} = 1.5 \ V to 13.75 \ V \\ 0 \ m_{AV} \ V_{IN} = 2.9 \ V to 10 \ V \\ 0 \ m_{AV} \ V_{IN} = 3.2 \ V to 10 \ V \\ 0 \ m_{AV} \ V_{IN} = 3.2 \ V to 10 \ V \\ 0 \ m_{AV} \ V_{IN} = 3.9 \ V to 10 \ V \\ 10 \ m_{AV} \ V_{IN} = 2.9 \ V to 15 \ V \\ 10 \ m_{AV} \ V_{IN} = 2.9 \ V \\ 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 2.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 2.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \ V \\ 11 \ to 10 \ to 800 \ m_{AV} \ V_{IN} = 3.9 \$ |       |        |   |      |  |  |
|  | I <sub>OUT</sub> = 100 mA   |  |       | 1.1    | 1.2   |      |  |  |
| Dropout voltage, V <sub>DO</sub> (2)   | I <sub>OUT</sub> = 500 mA   |  |       | 1.15   | 1.25  | V    |  |  |
|  | I <sub>OUT</sub> = 800 mA   |  |       | 1.2    | 1.3   |      |  |  |
| Current limit  | $V_{IN} - V_{OUT} = 5 \text{ V}, T_J = 25^{\circ}C^{(3)}$                                       |  | 0.8   | 1.2    | 1.6   | Α    |  |  |
| Minimum load current   | V <sub>IN</sub> = 15 V  | TLV1117  |       | 1.7    | 5   | mA   |  |  |
| Quiescent current  | V <sub>IN</sub> ≤ 15 V  |  |       | 5      | 10  | mA   |  |  |
| Thermal regulation   | 30-ms pulse, T <sub>A</sub> = 25°C  |  |       | 0.01   | 25 1.27 1.5 1.515 1.5 1.545 1.8 1.818 1.8 1.854 2.5 2.525 2.5 2.550 3.3 3.333 3.365 5.0 5.050 5.0 5.100 5% 0.2% — 1 6 1 6 1 6 1 1 6 1 10 2% 0.4% — 1 10 1 10 1 10 1 10 1 10 1 10 1 10 1 | %/W  |  |  |
| Ripple rejection   | $V_{IN} - V_{OUT} = 3 \text{ V}, V_{ripple} = 1 \text{ V}_{pp}, f = 120 \text{ Hz}$             |  | 60    | 75     |   | dB   |  |  |
| ADJ pin current  |   |  |       | 80     | 120   | μΑ   |  |  |
| Change in ADJ pin current  | $V_{IN} - V_{OUT} = 1.4 \text{ V to } 10 \text{ V}, I_{OUT} = 10 \text{ mA to } 800 \text{ mA}$ |  |       | 0.2    | 5   | μΑ   |  |  |
| Temperature stability  | T <sub>J</sub> = full range   |  |       | 0.5%   |   |      |  |  |
| Long-term stability  | 1000 hrs, No load, T <sub>A</sub> = 125°C   |  |       | 0.3%   |   |      |  |  |
|  | f = 10 Hz to 100 kHz  |  |       | 0.003% |   | _    |  |  |

<sup>(1)</sup> All characteristics are measured with a 10-µF capacitor across the input and a 10-µF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

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 <sup>(2)</sup> Dropout is defined as the V<sub>IN</sub> to V<sub>OUT</sub> differential at which V<sub>OUT</sub> drops 100 mV below the value of V<sub>OUT</sub>, measured at V<sub>IN</sub> = V<sub>OUT(nom)</sub> + 1.5 V.
 (3) Current limit test specified under recommended operating conditions.



# 7.6 TLV1117I Electrical Characteristics

 $T_J = -40$ °C to 125°C, all typical values are at  $T_J = 25$ °C (unless otherwise noted)

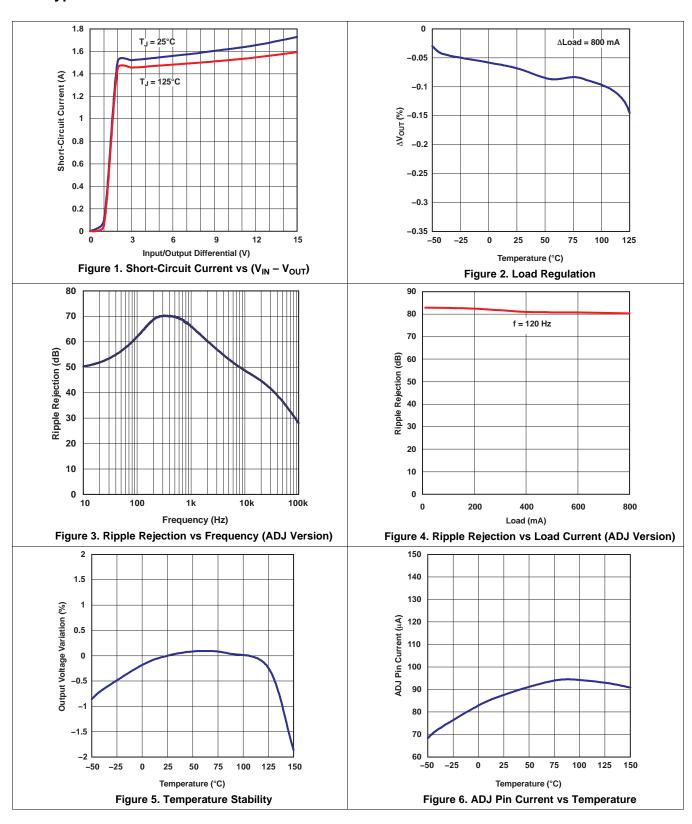
| PARAMETER   | TEST CONDITIONS <sup>(1)</sup>  |              | MIN   | TYP   | MAX   | UNIT |
|---|---|--------------|-------|---|---|------|
| Deference voltage \/  | $V_{IN} - V_{OUT} = 2 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$           | TI \/4447    | 1.238 | 1.25  | 1.262   |      |
| Reference voltage, v <sub>REF</sub>   | $V_{IN} - V_{OUT} = 1.4 \text{ V to } 10 \text{ V}, I_{OUT} = 10 \text{ mA to } 800 \text{ mA}$ | TLV1117      | 1.200 | 1.25  | 1.29  |      |
|   | V <sub>IN</sub> = 3.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                        | TLV1117-15   | 1.485 | 1.5   | 1.262   |      |
| Reference voltage, V <sub>REF</sub> Output voltage, V <sub>OUT</sub> Line regulation  Load regulation  Dropout voltage, V <sub>DO</sub> (2)  Current limit Minimum load current Quiescent current Thermal regulation Ripple rejection | V <sub>IN</sub> = 2.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                 | 1.44         | 1.5   | 1.56  |   |      |
|   | V <sub>IN</sub> = 3.8 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                        | TI \/4447.40 | 1.782 | 1.8   | 1.818   |      |
|   | V <sub>IN</sub> = 3.2 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                 | TLV1117-18   | 1.728 | 1.8   | 1.872   | \/   |
| Output voltage V  | $V_{IN} = 4.5 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$                   | TL \/4447.05 | 2.475 | 2.5   | 2.525   | V    |
| Output voltage, v <sub>OUT</sub>  | V <sub>IN</sub> = 3.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                 | TLV1117-25   | 2.4   | 2.5   | 2.6   |      |
|   | V <sub>IN</sub> = 5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                          | TI \/4447.00 | 3.267 | 3.3   | 3.333   |      |
| Line regulation   | V <sub>IN</sub> = 4.75 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA                                | TLV1117-33   | 3.168 | 3.3   | 3.432   |      |
|   | V <sub>IN</sub> = 7 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C                          | TI \/4447.50 | 4.95  | 5.0   | 5.05  |      |
|   | V <sub>IN</sub> = 6.5 V to 12 V, I <sub>OUT</sub> = 0 to 800 mA                                 | TLV1117-50   | 4.80  | 5.0   | 5.20  |      |
|   | $I_{OUT} = 10 \text{ mA}, V_{IN} - V_{OUT} = 1.5 \text{ V to } 13.75 \text{ V}$                 | TLV1117      |       | 0.035%  | 0.3%  | _    |
|   | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 2.9 V to 10 V  | TLV1117-15   |       | 1   | 10  |      |
| Line regulation   | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 3.2 V to 10 V  | TLV1117-18   |       | 1   | 10  |      |
|   | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 3.9 V to 10 V  | TLV1117-25   |       | 1   | 10  | mV   |
|   | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 4.75 V to 15 V                                       | TLV1117-33   |       | 1   | 10  |      |
|   | I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 6.5 V to 15 V  | TLV1117-50   |       | 1   | 1.515 1.56 1.818 1.872 2.525 2.6 3.333 3.432 5.05 5.20 0.3% 10 10 10 10 10 15 0.5% 15 15 15 15 15 15 15 15 15 15 15 15 17 15 18 18 18 18 18 18 18 18 18 18 18 18 18 |      |
| Load regulation   | $I_{OUT}$ = 10 mA to 800 mA, $V_{IN} - V_{OUT}$ = 3 V   | TLV1117      |       | 0.2%  | 0.5%  | _    |
|   | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 2.9 V   | TLV1117-15   |       | 1   | 15  |      |
| Lood regulation   | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 3.2 V   | TLV1117-18   |       | 1   | 15  |      |
| Load regulation   | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 3.9 V   | TLV1117-25   |       | 1   | 15  | mV   |
| Load regulation  Dropout voltage, V <sub>DO</sub> (2)  Current limit  Minimum load current  | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 4.75 V  | TLV1117-33   |       | 1   | 15  |      |
|   | I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 6.5 V   | TLV1117-50   |       | 1   | 20  |      |
|   | I <sub>OUT</sub> = 100 mA   |              |       | 1.1   | 1.3   |      |
| Dropout voltage, V <sub>DO</sub> (2)  | I <sub>OUT</sub> = 500 mA   |              | 1.15  | 1.35  | V   |      |
|   | I <sub>OUT</sub> = 800 mA   |              |       | 485         1.5         1.515           1.44         1.5         1.56           .782         1.8         1.872           .475         2.5         2.525           2.4         2.5         2.6           .267         3.3         3.333           .168         3.3         3.432           4.95         5.0         5.05           4.80         5.0         5.20           0.035%         0.3%           1         10           1         10           1         10           1         15           0.2%         0.5%           1         15           1         15           1         15           1         15           1         15           1         15           1         15           1         15           1         15           1         16           1         13           1         15           1         15           1         13           1         15           1         13 <td></td> |   |      |
| Current limit   | $V_{IN} - V_{OUT} = 5 \text{ V}, T_J = 25^{\circ}\text{C}^{(3)}$                                |              | 0.8   | 1.2   | 1.6   | Α    |
| Minimum load current  | V <sub>IN</sub> = 15 V  | TLV1117      |       | 1.7   | 5   | mA   |
| Quiescent current   | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$   |              |       | 15  | mA  |      |
| Thermal regulation  | 30-ms pulse, T <sub>A</sub> = 25°C  |              |       | 0.01  | 0.1   | %/W  |
| Ripple rejection  | $V_{IN} - V_{OUT} = 3 \text{ V}, V_{ripple} = 1 \text{ V}_{pp}, f = 120 \text{ Hz}$             |              | 60    | 75  |   | dB   |
| ADJ pin current   |   |              |       | 80  | μΑ  |      |
| Change in ADJ pin current   | $V_{IN} - V_{OUT} = 1.4 \text{ V to } 10 \text{ V}, I_{OUT} = 10 \text{ mA to } 800 \text{ mA}$ |              |       | 0.2   | 10  | μΑ   |
| Temperature stability   | T <sub>J</sub> = full range   |              |       | 0.5%  |   |      |
| Long-term stability   | 1000 hrs, No load, T <sub>A</sub> = 125°C   |              |       | 0.3%  |   | _    |
| Output noise voltage<br>(% of V <sub>OUT</sub> )  | f = 10 Hz to 100 kHz  |              |       | 0.003%  |   | _    |

<sup>(1)</sup> All characteristics are measured with a 10-µF capacitor across the input and a 10-µF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

 <sup>(2)</sup> Dropout is defined as the V<sub>IN</sub> to V<sub>OUT</sub> differential at which V<sub>OUT</sub> drops 100 mV below the value of V<sub>OUT</sub>, measured at V<sub>IN</sub> = V<sub>OUT(nom)</sub> + 1.5 V.
 (3) Current limit test specified under recommended operating conditions

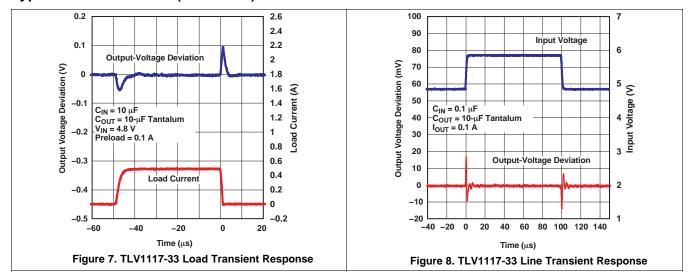


# 7.7 Typical Characteristics





# **Typical Characteristics (continued)**



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### 8 Detailed Description

#### 8.1 Overview

The TLV1117 device is a positive low-dropout voltage regulator designed to provide up to 800 mA of output current. The device is available in 1.5-V, 1.8-V, 2.5-V, 3.3-V, 5-V, and adjustable-output voltage options. All internal circuitry is designed to operate down to 1-V input-to-output differential. Dropout voltage is specified at a maximum of 1.3 V at 800 mA, decreasing at lower load currents.

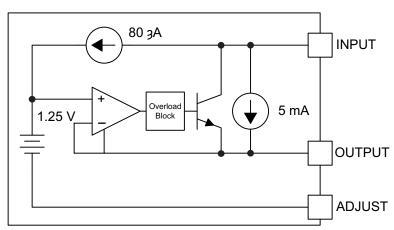
The TLV1117 device is designed to be stable with tantalum and aluminum electrolytic output capacitors having an ESR between 0.2  $\Omega$  and 10  $\Omega$ .

Unlike pnp-type regulators, in which up to 10% of the output current is wasted as quiescent current, the quiescent current of the TLV1117 device flows into the load, increasing efficiency.

The TLV1117C device is characterized for operation over the virtual junction temperature range of 0°C to 125°C, and the TLV1117I device is characterized for operation over the virtual junction temperature range of –40°C to 125°C.

#### 8.2 Functional Block Diagram

### **Functional Block Diagram**



#### 8.3 Feature Description

#### 8.3.1 NPN Output Drive

NPN output topology provides lower output impedance than most LDOs. However, an output capacitor is required. To support maximum current and lowest temperature, 1.4-V headroom is recommended (less for lower currents)  $(V_1 - V_0)$ .

#### 8.3.2 Overload Block

Current limiting and over temperature shutdown protects against overload or under heat sinking.

#### 8.3.3 Programmable Feedback

Op amp with 1.25-V offset input at the ADJUST pin provides easy output voltage programming. For current regulation applications, a single resistor whose resistance value is 1.25 V / IOUT and power rating is greater than  $(1.25 \text{ V})^2$  / R should be used. For voltage regulation applications, two resistors set the output voltage.

#### 8.4 Device Functional Modes

#### 8.4.1 Normal operation

The device OUTPUT pin will source current necessary to make OUTPUT pin 1.25 V greater than ADJUST terminal to provide output regulation.



## **Device Functional Modes (continued)**

### 8.4.2 Operation With Low Input Voltage

The adjustable version of the device requires 1-V headroom  $(V_1 - V_0)$  to operate in regulation. With less headroom, the device may drop out and OUTPUT voltage will be INPUT voltage minus drop out voltage.

#### 8.4.3 Operation at Light Loads

The device passes its bias current to the OUTPUT pin. The load or feedback must consume this minimum current for regulation or the output may be too high.

## 8.4.4 Operation in Self Protection

When an overload occurs the device will shut down the output stage or reduce the output current to prevent device damage. The device will automatically reset from the overload. The output may be reduced or alternate between on and off until the overload is removed.

# 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Typical Application

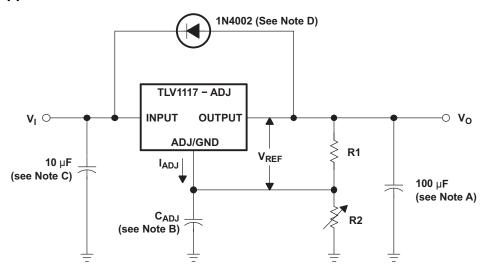


Figure 9. Basic Adjustable Regulator

The adjustable version of the TLV1117 will take a 2.7 to 15-V input. The voltage  $V_{REF}$  refers to the voltage between the output and the ADJUST pin, typically 1.25 V. The  $V_{REF}$  voltage causes a current to flow across R1, which is the same current that will flow across R2 (minus the negligible 50- $\mu$ A  $I_{ADJ}$ ). Therefore, R2 can be adjusted to create a larger voltage drop from GND and set the output voltage. The output voltage equation is described in *Detailed Design Procedure*.

#### 9.1.1 Design Requirements

- (A) Output capacitor selection is critical for regulator stability. Larger C<sub>OUT</sub> values benefit the regulator by improving transient response and loop stability. This device is designed to be stable with tantalum and aluminum electrolytic output capacitors having an ESR between 0.2 Ω and 10 Ω.
- (B) C<sub>ADJ</sub> can be used to improve ripple rejection. If C<sub>ADJ</sub> is used, a C<sub>OUT</sub> that is larger in value than C<sub>ADJ</sub> must be used.
- (C) C<sub>IN</sub> is recommended if TLV1117 device is not located near the power-supply filter.
- (D) An external diode is recommended to protect the regulator if the input instantaneously is shorted to GND.

#### 9.1.2 Detailed Design Procedure

The output voltage can be calculated as shown in Figure 10:

$$V_{OUT} = V_{REF} \left( 1 + \frac{R2}{R1} \right) + \left( I_{ADJ} \times R2 \right)$$

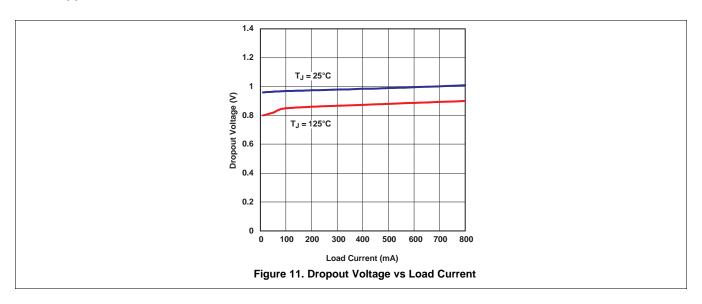
Figure 10.

 $I_{ADJ}$  can be neglected in most applications because its value is approximately 80  $\mu A$ .



# **Typical Application (continued)**

#### 9.1.3 Application Curves



# 10 Power Supply Recommendations

The fixed and adjustable versions of the TLV1117 have different recommended ranges of operating voltage. Refer to *Recommended Operating Conditions* for specific operating ranges.

## 11 Layout

### 11.1 Layout Guidelines

One or two input capacitors are recommended if the TLV1117 is not located near its power supply output filter capacitor. These capacitors can filter high-frequency noise and mitigate brief voltage surges from the input. Traces on the input and output pins of the device should be wide enough to support the full range of current needed in the application to minimize IxR drop.

### 11.2 Layout Example

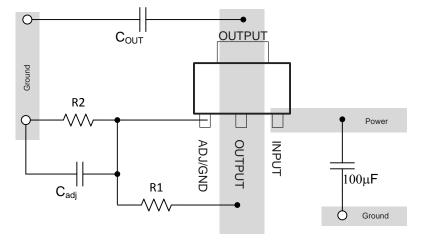


Figure 12. Layout Example

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Product Folder Links: *TLV1117* 



# 12 Device and Documentation Support

#### 12.1 Trademarks

All trademarks are the property of their respective owners.

## 12.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 12.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms and definitions.

# 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser based versions of this data sheet, refer to the left hand navigation.

Product Folder Links: TLV1117

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# **PACKAGING INFORMATION**

| Orderable Device  | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | Device Marking (4/5) | Samples |
|-------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|----------------------|---------|
| TLV1117-15CDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | T2                   | Samples |
| TLV1117-15CDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | T2                   | Samples |
| TLV1117-15CDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | T2                   | Samples |
| TLV1117-15CDRJR   | ACTIVE     | SON          | DRJ                | 8    | 3000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 125     | ZYH                  | Samples |
| TLV1117-15IDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | Т3                   | Samples |
| TLV1117-15IDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | Т3                   | Samples |
| TLV1117-15IKVURG3 | ACTIVE     | TO-252       | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | -40 to 125   | ZF15                 | Samples |
| TLV1117-18CDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | T4                   | Samples |
| TLV1117-18CDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | T4                   | Samples |
| TLV1117-18CDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | T4                   | Samples |
| TLV1117-18CDRJR   | ACTIVE     | SON          | DRJ                | 8    | 3000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 125     | ZYK                  | Samples |
| TLV1117-18CKVURG3 | ACTIVE     | TO-252       | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | 0 to 125     | ZE18                 | Samples |
| TLV1117-18IDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | T5                   | Samples |
| TLV1117-18IDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | T5                   | Samples |
| TLV1117-18IDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | T5                   | Samples |
| TLV1117-18IDRJR   | ACTIVE     | SON          | DRJ                | 8    | 1000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 125   | ZYL                  | Samples |
| TLV1117-18IKVURG3 | ACTIVE     | TO-252       | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | -40 to 125   | ZF18                 | Samples |
| TLV1117-25CDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | Т6                   | Samples |
| TLV1117-25CDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | Т6                   | Samples |
| TLV1117-25CDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | Т6                   | Samples |





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| Orderable Device  | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|-------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| TLV1117-25CKVURG3 | ACTIVE     | TO-252       | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | 0 to 125     | ZE25                    | Samples |
| TLV1117-25IDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | T8                      | Samples |
| TLV1117-25IDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | Т8                      | Samples |
| TLV1117-25IDRJR   | ACTIVE     | SON          | DRJ                | 8    | 3000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 125   | ZYN                     | Samples |
| TLV1117-33CDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V3                      | Samples |
| TLV1117-33CDCYG3  | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V3                      | Samples |
| TLV1117-33CDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V3                      | Samples |
| TLV1117-33CDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V3                      | Samples |
| TLV1117-33CDRJR   | ACTIVE     | SON          | DRJ                | 8    | 1000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 125     | ZYP                     | Samples |
| TLV1117-33CKVURG3 | ACTIVE     | TO-252       | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | 0 to 125     | ZE33                    | Samples |
| TLV1117-33IDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | (V3, VS)                | Samples |
| TLV1117-33IDCYG3  | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | (V3, VS)                | Samples |
| TLV1117-33IDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | VS                      | Samples |
| TLV1117-33IDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | VS                      | Samples |
| TLV1117-33IDRJR   | ACTIVE     | SON          | DRJ                | 8    | 1000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 125   | ZYR                     | Samples |
| TLV1117-33IKVURG3 | ACTIVE     | TO-252       | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | -40 to 125   | ZF33                    | Samples |
| TLV1117-50CDCY    | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | VT                      | Samples |
| TLV1117-50CDCYG3  | ACTIVE     | SOT-223      | DCY                | 4    | 80             | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | VT                      | Samples |
| TLV1117-50CDCYR   | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | VT                      | Samples |
| TLV1117-50CDCYRG3 | ACTIVE     | SOT-223      | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | 0 to 125     | VT                      | Samples |
| TLV1117-50CDRJR   | ACTIVE     | SON          | DRJ                | 8    | 3000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 125     | ZE50                    | Samples |





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| Orderable Device  | Status (1) | Package Type     | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan            | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | <b>Device Marking</b> (4/5) | Samples |
|-------------------|------------|------------------|--------------------|------|----------------|---------------------|-------------------------------|---------------------|--------------|-----------------------------|---------|
| TLV1117-50CKVURG3 | ACTIVE     | TO-252           | KVU                | 3    | 2500           | RoHS & Green        | SN                            | Level-3-260C-168 HR | 0 to 125     | ZE50                        | Samples |
| TLV1117-50IDCY    | ACTIVE     | SOT-223          | DCY                | 4    | 80             | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | -40 to 125   | VU                          | Samples |
| TLV1117-50IDCYR   | ACTIVE     | SOT-223          | DCY                | 4    | 2500           | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | -40 to 125   | VU                          | Samples |
| TLV1117-50IDCYRG3 | ACTIVE     | SOT-223          | DCY                | 4    | 2500           | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | -40 to 125   | VU                          | Samples |
| TLV1117-50IDRJR   | ACTIVE     | SON              | DRJ                | 8    | 1000           | RoHS & Green        | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 125   | ZF50                        | Samples |
| TLV1117-50IDRJRG4 | ACTIVE     | SON              | DRJ                | 8    | 1000           | RoHS & Green        | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 125   | ZF50                        | Samples |
| TLV1117-50IKVURG3 | ACTIVE     | TO-252           | KVU                | 3    | 2500           | RoHS & Green        | SN                            | Level-3-260C-168 HR | -40 to 125   | ZF50                        | Samples |
| TLV1117CDCY       | ACTIVE     | SOT-223          | DCY                | 4    | 80             | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V4                          | Samples |
| TLV1117CDCYG3     | ACTIVE     | SOT-223          | DCY                | 4    | 80             | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V4                          | Samples |
| TLV1117CDCYR      | ACTIVE     | SOT-223          | DCY                | 4    | 2500           | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V4                          | Samples |
| TLV1117CDCYRG3    | ACTIVE     | SOT-223          | DCY                | 4    | 2500           | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | 0 to 125     | V4                          | Samples |
| TLV1117CDRJR      | ACTIVE     | SON              | DRJ                | 8    | 1000           | RoHS & Green        | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 125     | ZYS                         | Samples |
| TLV1117CKCS       | ACTIVE     | TO-220           | KCS                | 3    | 50             | RoHS & Green        | SN                            | N / A for Pkg Type  | 0 to 125     | TLV1117C                    | Samples |
| TLV1117CKCT       | ACTIVE     | TO-220           | KCT                | 3    | 50             | RoHS &<br>Non-Green | SN                            | N / A for Pkg Type  | 0 to 125     | TLV1117C                    | Samples |
| TLV1117CKTTR      | ACTIVE     | DDPAK/<br>TO-263 | KTT                | 3    | 500            | RoHS & Green        | SN                            | Level-3-245C-168 HR | 0 to 125     | TLV1117C                    | Samples |
| TLV1117CKTTRG3    | ACTIVE     | DDPAK/<br>TO-263 | KTT                | 3    | 500            | RoHS & Green        | SN                            | Level-3-245C-168 HR | 0 to 125     | TLV1117C                    | Samples |
| TLV1117CKVURG3    | ACTIVE     | TO-252           | KVU                | 3    | 2500           | RoHS & Green        | SN                            | Level-3-260C-168 HR | 0 to 125     | TV1117                      | Samples |
| TLV1117IDCY       | ACTIVE     | SOT-223          | DCY                | 4    | 80             | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | -40 to 125   | V2                          | Samples |
| TLV1117IDCYG3     | ACTIVE     | SOT-223          | DCY                | 4    | 80             | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | -40 to 125   | V2                          | Samples |
| TLV1117IDCYR      | ACTIVE     | SOT-223          | DCY                | 4    | 2500           | RoHS & Green        | SN                            | Level-2-260C-1 YEAR | -40 to 125   | V2                          | Samples |

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| Orderable Device | Status (1) | Package Type     | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|------------|------------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| TLV1117IDCYRG3   | ACTIVE     | SOT-223          | DCY                | 4    | 2500           | RoHS & Green | SN                            | Level-2-260C-1 YEAR | -40 to 125   | V2                      | Samples |
| TLV1117IDRJR     | ACTIVE     | SON              | DRJ                | 8    | 1000           | RoHS & Green | NIPDAU                        | Level-2-260C-1 YEAR | -40 to 125   | ZYT                     | Samples |
| TLV1117IKCS      | ACTIVE     | TO-220           | KCS                | 3    | 50             | RoHS & Green | SN                            | N / A for Pkg Type  | -40 to 125   | TLV1117I                | Samples |
| TLV1117IKCSE3    | ACTIVE     | TO-220           | KCS                | 3    | 50             | RoHS & Green | SN                            | N / A for Pkg Type  | -40 to 125   | TLV1117I                | Samples |
| TLV1117IKTTR     | ACTIVE     | DDPAK/<br>TO-263 | KTT                | 3    | 500            | RoHS & Green | SN                            | Level-3-245C-168 HR | -40 to 125   | TLV1117I                | Samples |
| TLV1117IKVURG3   | ACTIVE     | TO-252           | KVU                | 3    | 2500           | RoHS & Green | SN                            | Level-3-260C-168 HR | -40 to 125   | TY1117                  | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



# **PACKAGE OPTION ADDENDUM**

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# TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
|    | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TLV1117-15CDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-15CDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-15CDRJR   | SON             | DRJ                | 8    | 3000 | 330.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-15IDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-15IDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-15IKVURG3 | TO-252          | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-15IKVURG3 | TO-252          | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-18CDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 6.55       | 7.25       | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-18CDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-18CDRJR   | SON             | DRJ                | 8    | 3000 | 330.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-18CKVURG3 | TO-252          | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-18CKVURG3 | TO-252          | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-18IDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-18IDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 6.55       | 7.25       | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-18IDRJR   | SON             | DRJ                | 8    | 1000 | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-18IKVURG3 | TO-252          | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-18IKVURG3 | TO-252          | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-25CDCYR   | SOT-223         | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |



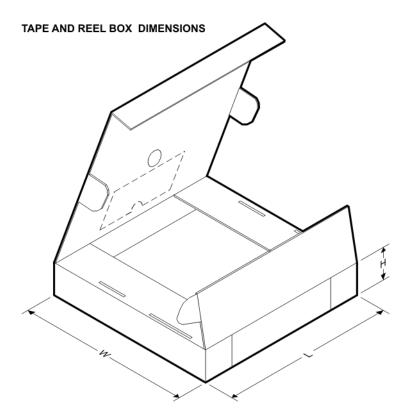
# **PACKAGE MATERIALS INFORMATION**

| Device            | Package<br>Type  | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|------------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TLV1117-25CDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-25CKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-25CKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-25IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-25IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-25IDRJR   | SON              | DRJ                | 8    | 3000 | 330.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-33CDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-33CDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-33CDRJR   | SON              | DRJ                | 8    | 1000 | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-33CKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-33CKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-33IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-33IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-33IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 6.55       | 7.25       | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-33IDRJR   | SON              | DRJ                | 8    | 1000 | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-33IKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-33IKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-50CDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-50CDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-50CDRJR   | SON              | DRJ                | 8    | 3000 | 330.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-50CKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-50CKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117-50IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-50IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117-50IDCYR   | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 6.55       | 7.25       | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117-50IDRJR   | SON              | DRJ                | 8    | 1000 | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117-50IKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117-50IKVURG3 | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117CDCYR      | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117CDCYR      | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 6.55       | 7.25       | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117CDCYR      | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117CDRJR      | SON              | DRJ                | 8    | 1000 | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117CKTTR      | DDPAK/<br>TO-263 | KTT                | 3    | 500  | 330.0                    | 24.4                     | 10.8       | 16.1       | 4.9        | 16.0       | 24.0      | Q2               |
| TLV1117CKTTR      | DDPAK/<br>TO-263 | KTT                | 3    | 500  | 330.0                    | 24.4                     | 10.8       | 16.3       | 5.11       | 16.0       | 24.0      | Q2               |
| TLV1117CKVURG3    | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117CKVURG3    | TO-252           | KVU                | 3    | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |
| TLV1117IDCYR      | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 6.55       | 7.25       | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117IDCYR      | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.05       | 7.4        | 1.9        | 8.0        | 12.0      | Q3               |
| TLV1117IDCYR      | SOT-223          | DCY                | 4    | 2500 | 330.0                    | 12.4                     | 7.0        | 7.42       | 2.0        | 8.0        | 12.0      | Q3               |
| TLV1117IDRJR      | SON              | DRJ                | 8    | 1000 | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLV1117IKTTR      | DDPAK/<br>TO-263 | KTT                | 3    | 500  | 330.0                    | 24.4                     | 10.8       | 16.3       | 5.11       | 16.0       | 24.0      | Q2               |





| Device         | Package<br>Type  | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|------------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TLV1117IKTTR   | DDPAK/<br>TO-263 | KTT                | 3 | 500  | 330.0                    | 24.4                     | 10.8       | 16.1       | 4.9        | 16.0       | 24.0      | Q2               |
| TLV1117IKVURG3 | TO-252           | KVU                | 3 | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.7        | 8.0        | 16.0      | Q2               |
| TLV1117IKVURG3 | TO-252           | KVU                | 3 | 2500 | 330.0                    | 16.4                     | 6.9        | 10.5       | 2.8        | 8.0        | 16.0      | Q2               |



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV1117-15CDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-15CDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-15CDRJR   | SON          | DRJ             | 8    | 3000 | 367.0       | 367.0      | 35.0        |
| TLV1117-15IDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-15IDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-15IKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-15IKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-18CDCYR   | SOT-223      | DCY             | 4    | 2500 | 336.0       | 336.0      | 48.0        |
| TLV1117-18CDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-18CDRJR   | SON          | DRJ             | 8    | 3000 | 367.0       | 367.0      | 35.0        |
| TLV1117-18CKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-18CKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-18IDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |



# **PACKAGE MATERIALS INFORMATION**

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV1117-18IDCYR   | SOT-223      | DCY             | 4    | 2500 | 336.0       | 336.0      | 48.0        |
| TLV1117-18IDRJR   | SON          | DRJ             | 8    | 1000 | 210.0       | 185.0      | 35.0        |
| TLV1117-18IKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-18IKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-25CDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-25CDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-25CKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-25CKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-25IDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-25IDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-25IDRJR   | SON          | DRJ             | 8    | 3000 | 367.0       | 367.0      | 35.0        |
| TLV1117-33CDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-33CDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-33CDRJR   | SON          | DRJ             | 8    | 1000 | 210.0       | 185.0      | 35.0        |
| TLV1117-33CKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-33CKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-33IDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-33IDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-33IDCYR   | SOT-223      | DCY             | 4    | 2500 | 336.0       | 336.0      | 48.0        |
| TLV1117-33IDRJR   | SON          | DRJ             | 8    | 1000 | 210.0       | 185.0      | 35.0        |
| TLV1117-33IKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-33IKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-50CDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-50CDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-50CDRJR   | SON          | DRJ             | 8    | 3000 | 367.0       | 367.0      | 35.0        |
| TLV1117-50CKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-50CKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-50IDCYR   | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117-50IDCYR   | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-50IDCYR   | SOT-223      | DCY             | 4    | 2500 | 336.0       | 336.0      | 48.0        |
| TLV1117-50IDRJR   | SON          | DRJ             | 8    | 1000 | 210.0       | 185.0      | 35.0        |
| TLV1117-50IKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117-50IKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117CDCYR      | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117CDCYR      | SOT-223      | DCY             | 4    | 2500 | 336.0       | 336.0      | 48.0        |
| TLV1117CDCYR      | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117CDRJR      | SON          | DRJ             | 8    | 1000 | 210.0       | 185.0      | 35.0        |
| TLV1117CKTTR      | DDPAK/TO-263 | KTT             | 3    | 500  | 350.0       | 334.0      | 47.0        |
| TLV1117CKTTR      | DDPAK/TO-263 | KTT             | 3    | 500  | 340.0       | 340.0      | 38.0        |
| TLV1117CKVURG3    | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117CKVURG3    | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |
| TLV1117IDCYR      | SOT-223      | DCY             | 4    | 2500 | 336.0       | 336.0      | 48.0        |
| TLV1117IDCYR      | SOT-223      | DCY             | 4    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117IDCYR      | SOT-223      | DCY             | 4    | 2500 | 350.0       | 334.0      | 47.0        |



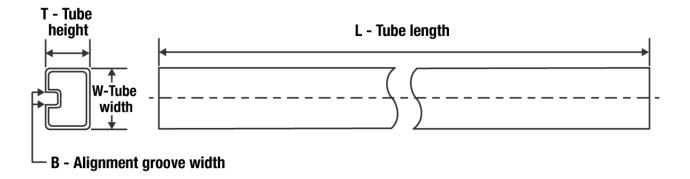
# **PACKAGE MATERIALS INFORMATION**

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV1117IDRJR   | SON          | DRJ             | 8    | 1000 | 210.0       | 185.0      | 35.0        |
| TLV1117IKTTR   | DDPAK/TO-263 | KTT             | 3    | 500  | 340.0       | 340.0      | 38.0        |
| TLV1117IKTTR   | DDPAK/TO-263 | KTT             | 3    | 500  | 350.0       | 334.0      | 47.0        |
| TLV1117IKVURG3 | TO-252       | KVU             | 3    | 2500 | 340.0       | 340.0      | 38.0        |
| TLV1117IKVURG3 | TO-252       | KVU             | 3    | 2500 | 350.0       | 334.0      | 47.0        |



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## **TUBE**



\*All dimensions are nominal

| Device           | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLV1117-15CDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-15IDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-18CDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-18IDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-25CDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-25IDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-33CDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-33CDCYG3 | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-33IDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-33IDCYG3 | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-50CDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-50CDCYG3 | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117-50IDCY   | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117CDCY      | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117CDCY      | DCY          | SOT-223      | 4    | 80  | 542.9  | 8.6    | 3606   | 2.67   |
| TLV1117CDCYG3    | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117CDCYG3    | DCY          | SOT-223      | 4    | 80  | 542.9  | 8.6    | 3606   | 2.67   |
| TLV1117CKCS      | KCS          | TO-220       | 3    | 50  | 532    | 34.1   | 700    | 9.6    |
| TLV1117CKCS      | KCS          | TO-220       | 3    | 50  | 532    | 34.1   | 700    | 9.6    |
| TLV1117CKCT      | KCT          | TO-220       | 3    | 50  | 534.5  | 33     | 7000   | 3.4    |
| TLV1117IDCY      | DCY          | SOT-223      | 4    | 80  | 542.9  | 8.6    | 3606   | 2.67   |
| TLV1117IDCY      | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117IDCYG3    | DCY          | SOT-223      | 4    | 80  | 542.9  | 8.6    | 3606   | 2.67   |
| TLV1117IDCYG3    | DCY          | SOT-223      | 4    | 80  | 559    | 8.6    | 500    | 3.6    |
| TLV1117IKCS      | KCS          | TO-220       | 3    | 50  | 532    | 34.1   | 700    | 9.6    |
| TLV1117IKCS      | KCS          | TO-220       | 3    | 50  | 532    | 34.1   | 700    | 9.6    |
| TLV1117IKCSE3    | KCS          | TO-220       | 3    | 50  | 532    | 34.1   | 700    | 9.6    |
| TLV1117IKCSE3    | KCS          | TO-220       | 3    | 50  | 532    | 34.1   | 700    | 9.6    |

# DCY (R-PDSO-G4)

#### PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters (inches).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC TO-261 Variation AA.

# DRJ (S-PWSON-N8)

# PLASTIC SMALL OUTLINE NO-LEAD



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. SON (Small Outline No-Lead) package configuration.

The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.

E. Package complies to JEDEC MO-229 variation WGGB.



# DRJ (S-PWSON-N8)

PLASTIC SMALL OUTLINE NO-LEAD

#### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

Exposed Thermal Pad Dimensions

4206882/F 01/11

NOTE: All linear dimensions are in millimeters



# DRJ (S-PWSON-N8)

# SMALL PACKAGE OUTLINE NO-LEAD



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat—Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="https://www.ti.com">https://www.ti.com</a>.
- E. Laser cutting apertures with electropolish and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for solder mask tolerances and vias tenting recommendations for vias placed in the thermal pad.



# KTT (R-PSFM-G3)

# PLASTIC FLANGE-MOUNT PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- 3. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
- ⚠ Falls within JEDEC T0—263 variation AA, except minimum lead thickness and minimum exposed pad length.



# KTT (R-PSFM-G3)

# PLASTIC FLANGE-MOUNT PACKAGE



NOTES: A.

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-SM-782 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release.

  Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.
- F. This package is designed to be soldered to a thermal pad on the board. Refer to the Product Datasheet for specific thermal information, via requirements, and recommended thermal pad size. For thermal pad sizes larger than shown a solder mask defined pad is recommended in order to maintain the solderable pad geometry while increasing copper area.





Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4205521-2/E







### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. Shape may vary per different assembly sites.

  4. Reference JEDEC registration TO-252.





NOTES: (continued)

- 5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002(www.ti.com/lit/slm002) and SLMA004 (www.ti.com/lit/slma004).
- 6. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.





NOTES: (continued)

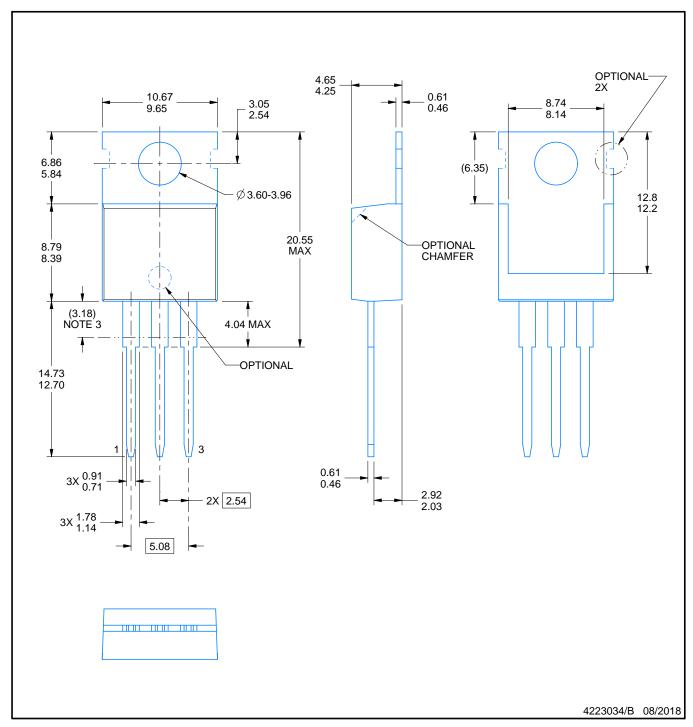


<sup>7.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations

design recommendations.

8. Board assembly site may have different recommendations for stencil design.

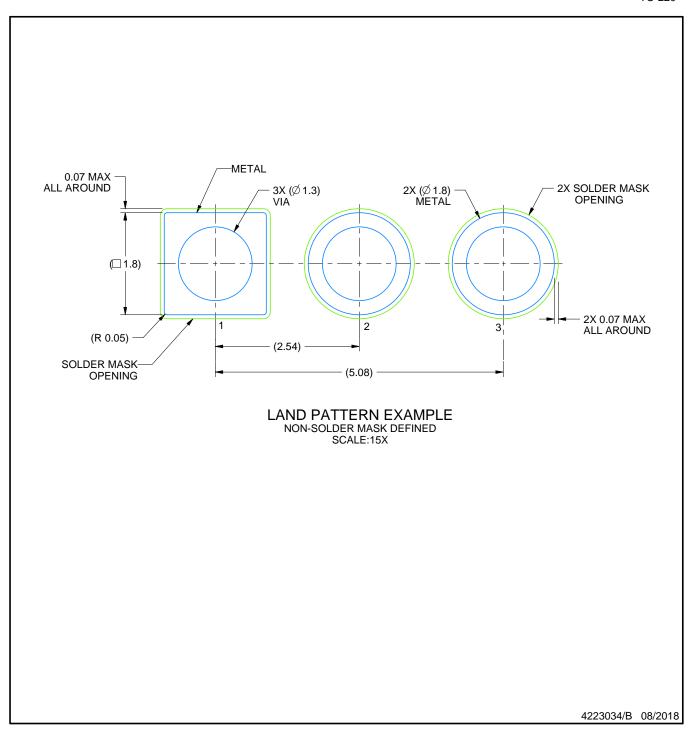




## NOTES:

- Dimensions are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. Lead dimensions are not controlled within this area.
- 4. Reference JEDEC registration TO-220.









#### NOTES:

- 1. Dimensions are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. Reference JEDEC registration TO-220.





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